

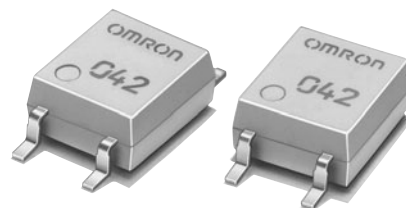
# G3VM-61GR1

## MOS FET Relays

### MOS FET Relays with 1-A switching Designed for Switching Minute Signals and Analog Signals.

- Upgraded G3VM-S1 Series.
- Continuous load current of 1 A.

RoHS compliant

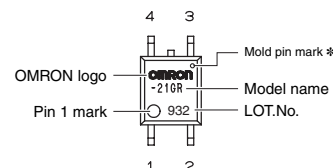
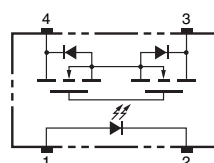


Note: The actual product is marked differently from the image shown here.

#### Application Examples

- Semiconductor test equipment
- Test & Measurement equipment
- Communication equipment
- Data loggers

#### Terminal Arrangement/Internal Connections



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\* The indentation in the corner diagonally opposite from the pin 1 mark is from a pin on the mold.

#### List of Models

Package type	Contact form	Terminals	Load voltage (peak value) *	Model	Minimum package quantity	
					Number per tube	Number per tape and reel
SOP4	1a (SPST-NO)	Surface-mounting Terminals	60 V	G3VM-61GR1	100	-
				G3VM-61GR1 (TR)	-	2,500

\* The AC peak and DC value are given for the load voltage.

#### Absolute Maximum Ratings (Ta = 25°C)

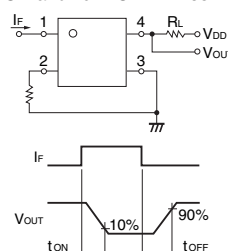
Item	Symbol	Rating	Unit	Measurement conditions
Input	LED forward current	IF	50	mA
	Repetitive peak LED forward current	IFP	1	A
	LED forward current reduction rate	$\Delta I_F / ^\circ\text{C}$	-0.5	mA/°C
	LED reverse voltage	VR	5	V
Output	Connection temperature	TJ	125	°C
	Load voltage (AC peak/DC)	VOFF	60	V
	Continuous load current (AC peak/DC)	IO	1000	mA
	ON current reduction rate	$\Delta I_O / ^\circ\text{C}$	-13.3	mA/°C
Dielectric strength between I/O (See note 1.)	Connection temperature	TJ	125	°C
	Dielectric strength between I/O (See note 1.)	VI-O	1500	Vrms
	Ambient operating temperature	Ta	-20 to +85	°C
	Ambient storage temperature	Tstg	-40 to +125	°C
Soldering temperature	Dielectric strength between I/O (See note 1.)	VI-O	1500	Vrms
	Ambient operating temperature	Ta	-20 to +85	°C
Soldering temperature	Ambient storage temperature	Tstg	-40 to +125	°C
	Soldering temperature	-	260	°C

Note: 1. The dielectric strength between the input and output was checked by applying voltage between all pins as a group on the LED side and all pins as a group on the light-receiving side.

#### Electrical Characteristics (Ta = 25°C)

Item	Symbol	Minimum	Typical	Maximum	Unit	Measurement conditions
Input	LED forward voltage	VF	1.0	1.15	1.3	V
	Reverse current	IR	-	10	μA	IF = 10 mA
	Capacity between terminals	CT	-	15	pF	VR = 5 V
	Trigger LED forward current	IFT	-	1.0	3	mA
Output	Maximum resistance with output ON	RON	-	0.25	0.7	Ω
	Current leakage when the relay is open	ILEAK	-	0.2	100	nA
	Capacity between terminals	Coff	-	90	pF	VOFF = 60 V
	Capacity between I/O terminals	CI-O	-	0.8	pF	V = 0, f = 1 MHz
Turn-ON time	Insulation resistance between I/O terminals	RI-O	1000	-	MΩ	f = 1 MHz, Vs = 0 V
	Turn-ON time	TON	-	1.4	3.0	ms
	Turn-OFF time	TOFF	-	0.6	1.0	ms
	Turn-OFF time	TOFF	-	0.6	1.0	ms

Note: 2. Turn-ON and Turn-OFF Times



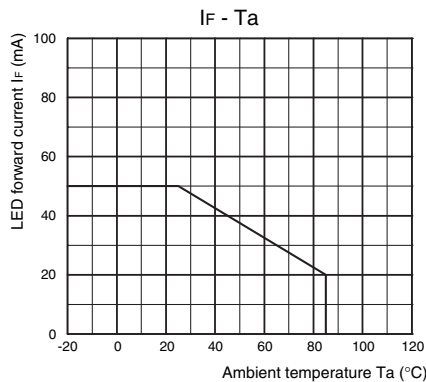
### Recommended Operating Conditions

Use the G3VM under the following conditions so that the Relay will operate properly.

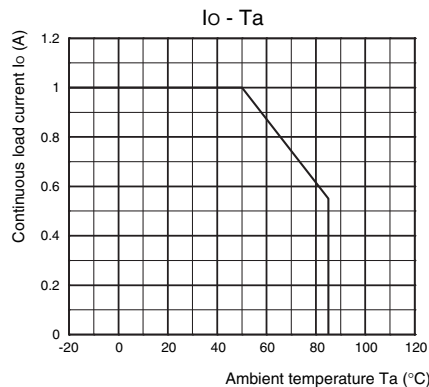
Item	Symbol	Minimum	Typical	Maximum	Unit
Load voltage (AC peak/DC)	$V_{DD}$	-	-	48	V
Operating LED forward current	$I_F$	5	10	20	mA
Continuous load current (AC peak/DC)	$I_O$	-	-	1000	mA
Ambient operating temperature	$T_a$	25	-	60	°C

### Engineering Data

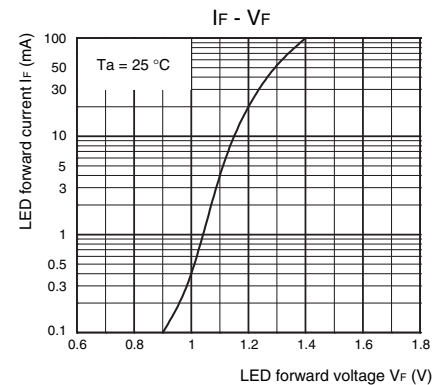
LED forward current vs. Ambient temperature



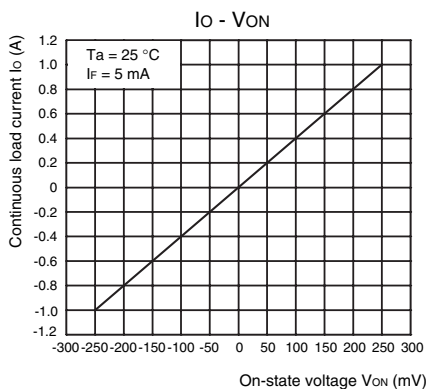
Continuous load current vs. Ambient temperature



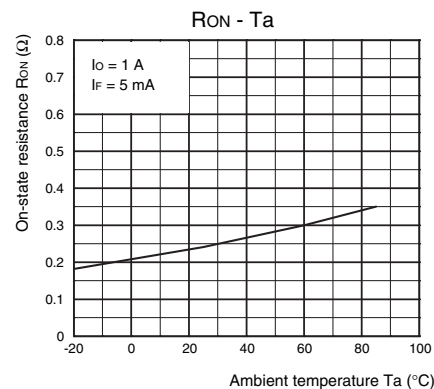
LED forward current vs. LED forward voltage



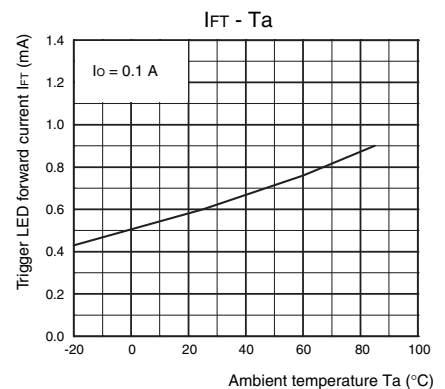
Continuous load current vs. On-state voltage



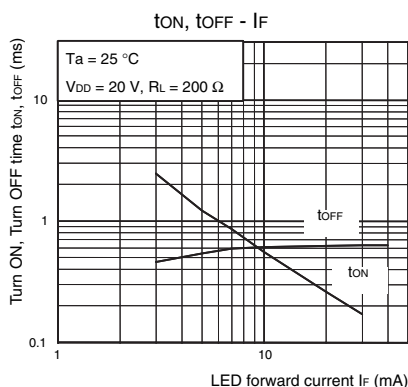
On-state resistance vs. Ambient temperature



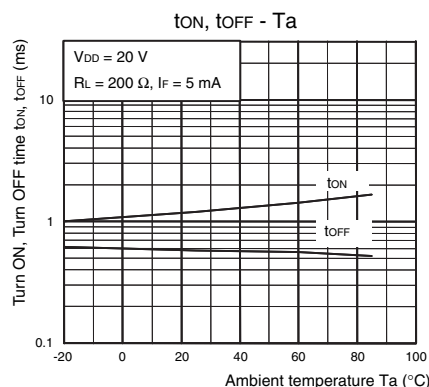
Trigger LED forward current vs. Ambient temperature



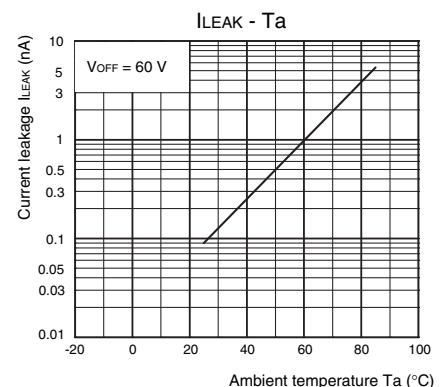
Turn ON, Turn OFF time vs. LED forward current



Turn ON, Turn OFF time vs. Ambient temperature



Current leakage vs. Ambient temperature

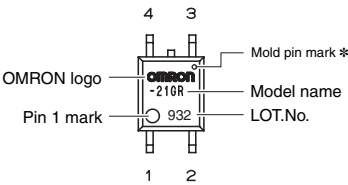


### Safety Precautions

- Refer to "Common Precautions" for all G3VM models.

## ■ Appearance

### SOP (Small Outline Package) SOP4



Note: The actual product is marked differently from the image shown here.

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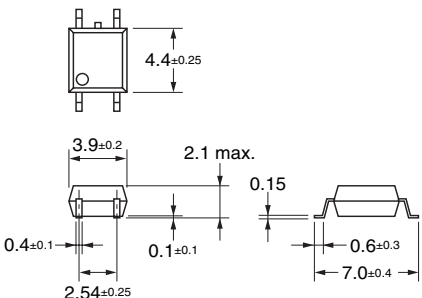
## ■ Dimensions

(Unit: mm)



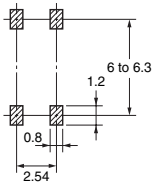
### Surface-mounting Terminals

Weight: 0.1 g



### Actual Mounting Pad Dimensions

(Recommended Value, TOP VIEW)



Note: The actual product is marked differently from the image shown here.

- Application examples provided in this document are for reference only. In actual applications, confirm equipment functions and safety before using the product.
- Consult your OMRON representative before using the product under conditions which are not described in the manual or applying the product to nuclear control systems, railroad systems, aviation systems, vehicles, combustion systems, medical equipment, amusement machines, safety equipment, and other systems or equipment that may have a serious influence on lives and property if used improperly. Make sure that the ratings and performance characteristics of the product provide a margin of safety for the system or equipment, and be sure to provide the system or equipment with double safety mechanisms.

Note: Do not use this document to operate the Unit.

OMRON Corporation

ELECTRONIC AND MECHANICAL COMPONENTS COMPANY

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